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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



In re Application of:) PATENT APPLICATION
Inventors: Hirohiko Nishiki, James M.)
Atkinson and Yukihiko Nakata)
Serial No.: Not Yet Assigned) Attorney Docket No.
Filed: Herewith) SLA 0452
Title: SYSTEM AND METHOD FOR)
ETCHING RESIN WITH AN)
OZONE WET ETCHING)
PROCESS)

**CERTIFICATE OF MAILING BY "EXPRESS MAIL"
UNDER 37 C.F.R. § 1.10**

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Date of Mailing: **January 7, 2002**

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Victoria A. Woods

Signature Date: January 7, 2002

Box PATENT APPLICATION
Commissioner for Patents
Washington, DC 20231

Sir:

Transmitted herewith for filing is a patent application identified as follows:

Inventors: Hirohiko Nishiki, James M. Atkinson and
Yukihiko Nakata

Title: SYSTEM AND METHOD FOR ETCHING RESIN WITH
AN OZONE WET ETCHING PROCESS

No. of pages in Specification: 19 No. of Claims: 20

No. of sheets of Drawings: 10 Formal: , Informal: X

Also enclosed are:

- A Declaration.
- An Assignment and Recordation Form Cover Sheet.
- Power of Attorney by Assignee.
- A certified copy of a priority application.
- A Verified Statement to establish small entity status.
- An Information Disclosure Statement under 37 C.F.R. §1.56.

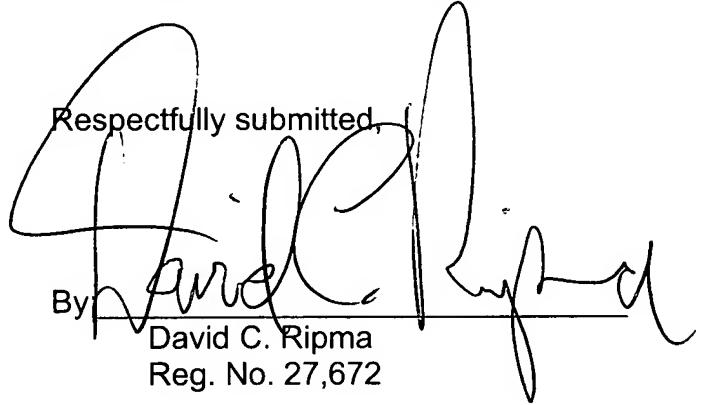
The filing fee pursuant to 37 C.F.R. §1.16 is determined as follows:

No. Filed	No. Extra	Rate Small Entity/ Other Than Small Entity	
Basic Fee		\$370.00 \$740.00	= \$ 740.00
Total Claims <u>20</u> - 20	<u>0</u>	X \$ 9.00 \$18.00	\$ 000.00
Independent Claims <u>4</u> - 3	<u>1</u>	X \$ 42.00 \$84.00	\$ 84.00
First Presentation of Multiple Dependent Claim(s) (0)		\$140.00 \$280.00	\$ 00.00
		Total	\$ 824.00

- If the difference is less than zero, enter "0".

- Please charge Deposit Account No. 19-1457 in the amount of (\$ 864.00) to cover the filing fee (\$824.00) and assignment recording fee (\$40.00). A duplicate copy of this authorization is enclosed.
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- The Commissioner is hereby authorized to charge underpayment of any fees, (including those listed below), or credit any overpayment associated with this communication to Deposit Account No. 19-1457. A duplicate copy of this authorization is enclosed.
- Any additional filing fees under 37 C.F.R. § 1.16.
- Any patent application processing fees under 37 C.F.R. § 1.17.

Date: Jan 7, 2002

Respectfully submitted,
By 
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